

20 MHz to 1.0 GHz IF Gain Block

Data Sheet

FEATURES

Fixed gain of 16 dB **Operation from 20 MHz to 1.0 GHz** Input and output internally matched to 50 Ω Integrated bias control circuit OIP3 45.5 dBm at 190 MHz 45.5 dBm at 380 MHz Noise figure 3.2 dB at 190 MHz 3.3 dB at 380 MHz P1dB of 18.9 dBm at 190 MHz Single 5 V power supply Low quiescent current of 97 mA MSL-1 rated SOT-89 package ESD rating of ±2 kV (Class 2) Pin-compatible with the 20 dB gain ADL5536

ADL5535

FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

The ADL5535 is a 16 dB linear amplifier that operates at frequencies up to 1 GHz. The device can be used in a wide variety of cellular, CATV, military, and instrumentation equipment.

The ADL5535 provides the highest dynamic range available from an internally matched IF gain block. This is accomplished by providing extremely low noise figures and very high OIP3 specifications simultaneously across the entire 1 GHz frequency range. The ADL5535 also provides extremely flat gain and P1dB over frequency, which are stable over temperature, power supply, and from device to device.

The device is internally matched to 50Ω at the input and output, making the ADL5535 very easy to implement in a wide variety of applications. Only input/output ac coupling capacitors, power supply decoupling capacitors, and an external inductor are required for operation.

The ADL5535 is fabricated on a GaAs HBT process and has an ESD rating of ± 2 kV (Class 2). The device is assembled in an MSL-1 rated SOT-89 package that uses an exposed paddle for excellent thermal impedance.

The ADL5535 consumes only 97 mA on a single 5 V supply and is fully specified for operation from -40° C to $+85^{\circ}$ C.

The ADL5535 is also pin-compatible with the 20 dB gain ADL5536. Fully populated evaluation boards are available for each amplifier.

Rev. A

Document Feedback

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

ADL5535* PRODUCT PAGE QUICK LINKS

Last Content Update: 09/27/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

ADL5535 Evaluation Board

DOCUMENTATION

Application Notes

- AN-1363: Meeting Biasing Requirements of Externally Biased RF/Microwave Amplifiers with Active Bias Controllers
- Broadband Biasing of Amplifiers General Application Note
- MMIC Amplifier Biasing Procedure Application Note
- Thermal Management for Surface Mount Components General Application Note

Data Sheet

• ADL5535: 20 MHz to 1.0 GHz IF Gain Block Data Sheet

TOOLS AND SIMULATIONS \square

- ADI RF Amplifier Library for Agilent ADS
- ADIsimPLL[™]
- ADIsimRF
- ADL5535 S-Parameters

REFERENCE DESIGNS

• CN0171

REFERENCE MATERIALS

Product Selection Guide

RF Source Booklet

DESIGN RESOURCES

- ADL5535 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all ADL5535 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

Submit feedback for this data sheet.

TABLE OF CONTENTS

Features	1
Functional Block Diagram	1
General Description	1
Revision History	2
Specifications	3
Typical Scattering Parameters (S-Parameters)	5
Absolute Maximum Ratings	6
ESD Caution	6
Pin Configuration and Function Descriptions	7
Typical Performance Characteristics	8

REVISION HISTORY

9/13-Rev. 0 to Rev. A

Moved Figure 13 and Figure 14	
Added Figure 15; Renumbered Sequentially	
Changes to Figure 17	11
Updated Outline Dimensions	15

4/10—Revision 0: Initial Version

Basic Connections 11
Soldering Information and Recommended PCB Land Pattern11
ACPR Performance 12
Error Vector Magnitude (EVM) Performance12
ADC Driving Application
Evaluation Board
Outline Dimensions
Ordering Guide15

SPECIFICATIONS

 V_{CC} = 5 V and T_{A} = 25°C, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
OVERALL FUNCTION					
Frequency Range		20		1000	MHz
FREQUENCY = 20 MHz					
Gain			16.7		dB
Output 1 dB Compression Point (P1dB)			17.7		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1$ MHz, output power (P _{OUT}) = 3 dBm per tone		41.5		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-59.5		dBc
Third Harmonic	$P_{OUT} = 0 dBm$		-93		dBc
Noise Figure			3.0		dB
FREQUENCY = 70 MHz					
Gain			16.5		dB
vs. Frequency	±50 MHz		±0.33		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.16		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.04		dB
Output 1 dB Compression Point (P1dB)			18.9		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1$ MHz, output power (P _{OUT}) = 3 dBm per tone		43.5		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-64		dBc
Third Harmonic	$P_{OUT} = 0 dBm$		-93		dBc
Noise Figure			3.0		dB
FREQUENCY = 190 MHz					
Gain		15.2	16.1	17.0	dB
vs. Frequency	±50 MHz		±0.06		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.17		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.04		dB
Output 1 dB Compression Point (P1dB)		17.8	18.9		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1 \text{ MHz}$, output power (P _{OUT}) = 3 dBm per tone		45.5		dBm
Second Harmonic	$P_{OUT} = 0 \text{ dBm}$		-60.2		dBc
Third Harmonic	$P_{OUT} = 0 \text{ dBm}$		-84.3		dBc
Noise Figure			3.2		dB
FREQUENCY = 380 MHz					
Gain		15.0	15.8	16.5	dB
vs. Frequency	±50 MHz		±0.08		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.17		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.05		dB
Output 1 dB Compression Point (P1dB)		17.8	18.9		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1 \text{ MHz}$, output power (P _{OUT}) = 3 dBm per tone		45.5		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-61.9		dBc
Third Harmonic	$P_{OUT} = 0 dBm$		-75		dBc
Noise Figure			3.3		dB
FREQUENCY = 748 MHz					
Gain			15.2		dB
vs. Frequency	±50 MHz		±0.10		dB
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±0.20		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.06		dB
Output 1 dB Compression Point (P1dB)			18.9		dBm
Output Third-Order Intercept (OIP3)	$\Delta t = 1$ MHz, output power (P _{OUT}) = 3 dBm per tone		42.0		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-52.6		dBc
	$P_{OUT} = 0 \text{ dBm}$		-68		dBc
Noise Figure		1	3.2		dB

Davamatar	Tast Canditians/Commonts	A4:	True	Max	11
Parameter	lest Conditions/Comments	wiin	тур	Max	Unit
FREQUENCY = 900 MHz					
Gain			15.1		dB
vs. Frequency	±50 MHz		±0.11		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.20		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.06		dB
Output 1 dB Compression Point (P1dB)			19.0		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1$ MHz, output power (P _{OUT}) = 3 dBm per tone		40.0		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-59.3		dBc
Third Harmonic	$P_{OUT} = 0 dBm$		-64.6		dBc
Noise Figure			3.2		dB
FREQUENCY = 1000 MHz					
Gain			14.9		dB
vs. Frequency	±50 MHz		±0.11		dB
vs. Temperature	$-40^{\circ}C \le T_A \le +85^{\circ}C$		±0.21		dB
vs. Supply Voltage	4.75 V to 5.25 V		±0.07		dB
Output 1 dB Compression Point (P1dB)			18.9		dBm
Output Third-Order Intercept (OIP3)	$\Delta f = 1$ MHz, output power (P _{OUT}) = 3 dBm per tone		39.5		dBm
Second Harmonic	$P_{OUT} = 0 dBm$		-51.4		dBc
Third Harmonic	Pout = 0 dBm		-63.1		dBc
Noise Figure			3.3		dB
POWER INTERFACE					
Supply Voltage (V _{cc})		4.5	5.0	5.5	V
Supply Current			97	115	mA
vs. Temperature	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$		±2.0		mA
Power Dissipation	$V_{CC} = 5 V$		0.5		W

TYPICAL SCATTERING PARAMETERS (S-PARAMETERS)

 V_{CC} = 5 V, T_A = 25°C, and the effects of the test fixture have been de-embedded up to the pins of the device.

Table 2.								
Frequency	S11		S21		S12		S22	
(MHz)	Magnitude (dB)	Angle (°)						
20	-13.03	-112.72	17.11	167.18	-19.70	+10.45	-14.78	-125.49
70	-18.32	-152.93	16.33	171.17	-19.67	+0.77	-15.85	-161.12
120	-19.04	-161.05	16.22	169.68	-19.66	-1.99	-15.99	-166.87
190	-19.31	-163.81	16.16	166.09	-19.65	-4.89	-15.97	-168.23
240	-19.35	-163.54	16.10	163.36	-19.65	-6.74	-15.91	-167.75
290	-19.26	-162.62	16.08	160.44	-19.65	-8.54	-15.81	-166.89
340	-19.24	-161.59	16.01	157.37	-19.66	-10.20	-15.70	-166.07
390	-19.12	-158.71	15.94	154.60	-19.65	-11.99	-15.53	-164.46
440	-18.88	-157.70	15.91	151.65	-19.65	-13.65	-15.28	-163.07
490	-18.58	-157.00	15.84	148.72	-19.69	-15.34	-15.02	-162.82
540	-18.35	-156.08	15.80	145.67	-19.71	-16.97	-14.80	-162.40
590	-18.12	-154.28	15.71	142.80	-19.70	-18.60	-14.58	-161.54
640	-17.82	-153.50	15.67	139.94	-19.71	-20.26	-14.31	-161.17
690	-17.57	-152.78	15.59	136.89	-19.73	-21.87	-14.07	-160.95
740	-17.30	-151.90	15.51	134.11	-19.74	-23.49	-13.82	-160.76
790	-17.04	-151.31	15.44	131.17	-19.75	-25.11	-13.58	-160.71
840	-16.76	-150.77	15.35	128.31	-19.77	-26.74	-13.34	-160.76
900	-16.41	-150.20	15.26	125.01	-19.79	-28.65	-13.05	-160.99
950	-16.15	-149.94	15.17	122.08	-19.80	-30.29	-12.82	-161.31
1000	-15.87	-149.69	15.08	119.42	-19.82	-31.88	-12.59	-161.67
1050	-15.60	-149.72	15.00	116.58	-19.84	-33.51	-12.38	-162.13
1100	-15.35	-149.61	14.89	113.89	-19.86	-35.10	-12.17	-162.71
1150	-15.08	-149.74	14.81	111.22	-19.88	-36.69	-11.97	-163.25
1200	-14.86	-149.84	14.70	108.43	-19.90	-38.29	-11.79	-163.86
1250	-14.58	-149.97	14.61	105.97	-19.92	-39.90	-11.59	-164.52
1300	-14.35	-150.33	14.52	103.20	-19.94	-41.52	-11.41	-165.22
1350	-14.11	-150.67	14.41	100.66	-19.96	-43.13	-11.25	-166.05
1400	-13.90	-151.10	14.32	98.10	-19.99	-44.68	-11.08	-166.79
1450	-13.69	-151.43	14.21	95.51	-20.02	-46.23	-10.93	-167.47
1500	-13.46	-151.86	14.11	93.03	-20.04	-47.82	-10.78	-168.33
1550	-13.26	-152.41	14.02	90.50	-20.06	-49.37	-10.63	-169.12

ABSOLUTE MAXIMUM RATINGS

Table 3.

	· · · · · · · · · · · · · · · · · · ·
Parameter	Rating
Supply Voltage, V _{CC}	6.5 V
Input Power (Referred to 50 Ω)	20 dBm
Internal Power Dissipation (Paddle Soldered)	650 mW
θ_{JA} (Junction to Air)	30.7°C/W
θ_{JC} (Junction to Paddle)	5.0°C/W
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 60 sec)	240°C
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	–65°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	RFIN	RF Input. This pin requires a dc blocking capacitor.
2	GND	Ground. Connect this pin to a low impedance ground plane.
3	RFOUT	RF Output and Supply Voltage. A dc bias is provided to this pin through an inductor that is connected to the external power supply. The RF path requires a dc blocking capacitor.
(2)	Exposed Paddle	Exposed Paddle. The exposed paddle is internally connected to GND and must be soldered to a low impedance ground plane.

TYPICAL PERFORMANCE CHARACTERISTICS





Figure 4. Gain vs. Frequency and Temperature



Figure 5. Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency



Figure 6. P1dB and OIP3 vs. Frequency and Temperature



Figure 7. OIP3 vs. Output Power (POUT) and Frequency



Figure 8. Noise Figure vs. Frequency and Temperature

Data Sheet

ADL5535



Figure 9. Single-Tone Harmonics vs. Frequency, $P_{OUT} = 0 \ dBm$



Figure 10. Gain Distribution at 190 MHz







Figure 12. OIP3 Distribution at 190 MHz, $P_{OUT} = 3 \text{ dBm}$



Figure 13. Noise Figure Distribution at 190 MHz



Figure 15. Supply Current vs. Pout at Various Temperatures



BASIC CONNECTIONS

The basic connections for operating the ADL5535 are shown in Figure 16. Recommended components are listed in Table 5. The input and output should be ac-coupled with appropriately sized capacitors (device characterization was performed with 0.1 μF capacitors). A 5 V dc bias is supplied to the amplifier through the bias inductor connected to RFOUT (Pin 3). The bias voltage should be decoupled using a 1 μF capacitor, a 1.2 nF capacitor, and a 68 pF capacitor.



SOLDERING INFORMATION AND RECOMMENDED PCB LAND PATTERN

Figure 17 shows the recommended land pattern for the ADL5535. To minimize thermal impedance, the exposed paddle on the package underside, along with Pin 2, should be soldered to a ground plane. If multiple ground layers exist, they should be stitched together using vias. For more information about land pattern design and layout, refer to the AN-772 Application Note, *A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP)*.



Figure 17. Recommended Land Pattern

Tuble 5, Recommended Components for Dusie Connection	Table 5. Re	ecommended (Components	for Basic	Connections
--	-------------	--------------	------------	-----------	-------------

Frequency	C1	C2	L1	C4	C5	C6
20 MHz to 1000 MHz	0.1 μF	0.1 μF	470 nH (Coilcraft 0603LS-NX or equivalent)	68 pF	1.2 nF	1 μF

ACPR PERFORMANCE

Figure 18 shows a plot of the adjacent channel power ratio (ACPR) vs. P_{OUT} for the ADL5535. The signal type used is a single wideband code division multiple access (W-CDMA) carrier (Test Model 1-64). This signal is generated by a very low ACPR source. ACPR is measured at the output by a high dynamic range spectrum analyzer that incorporates an instrument noise-correction function. At an output power level of +8 dBm, ACPR is still very low at -65 dBc, making the device suitable for use in driver applications.



ERROR VECTOR MAGNITUDE (EVM) PERFORMANCE

Error vector magnitude (EVM) is a measure used to quantify the performance of a digital radio transmitter or receiver. A signal received by a receiver has all constellation points at their ideal locations; however, various imperfections in the implementation (such as magnitude imbalance, noise floor, and phase imbalance) cause the actual constellation points to deviate from their ideal locations. The ADL5535 shows excellent performance when used with higher-order modulation schemes, such as a 16 QAM. Figure 19 illustrates the EVM performance of the ADL5535 when driven with a 16 QAM 10 Msym/s signal. Degradation of the EVM performance starts to occur at an output power of +12 dBm.



Figure 19. EVM Performance vs. Pout with a 16 QAM, 10 Msym/s Signal

ADC DRIVING APPLICATION

The ADL5535 is a high linearity, fixed gain IF amplifier suitable for use as an ADC driver. Figure 23 shows the schematic of the ADL5535 driving the AD9268 16-bit analog-to-digital converter (ADC). The ADL5535 has a single-ended input and output impedance of 50 Ω . A 1:1 impedance transformer, along with termination resistors and series ferrite beads, are used to present a 50 Ω load for the antialiasing filter interface. The filter interface between the ADL5535 and the AD9268 is a sixth-order Butterworth low-pass filter. The interface provides a 50 MHz, 1 dB bandwidth centered around 175 MHz. Following the sixth-order filter, a shunt LC tank circuit was inserted to further reduce the low frequency response of the filter, giving more of a band-pass response to the filter. The normalized wideband response is shown in Figure 20.



in Figure 23



Figure 21. Measured Single-Tone Performance of the Circuit Shown in Figure 23



Figure 22. Measured Two-Tone Performance of the Circuit Shown in Figure 23



Figure 23. Schematic of the ADL5535 Driving the AD9268 16-Bit ADC

EVALUATION BOARD

Figure 24 shows the evaluation board layout, and Figure 25 shows the schematic for the ADL5535 evaluation board. The board is powered by a single 5 V supply.

The components used on the board are listed in Table 6. Power can be applied to the board through clip-on leads (VCC and GND).





Figure 25. Evaluation Board Schematic

Table 6. Evaluation Board Components

	1	
Component	Description	Default Value
C1, C2	AC coupling capacitors	0.1 μF, 0402
L1	DC bias inductor	470 nH, 0603 (Coilcraft 0603LS-NX or equivalent)
VCC, GND	Clip-on terminals for power supply	
C4	Power supply decoupling capacitor	68 pF, 0603
C5	Power supply decoupling capacitor	1.2 nF, 0603
C6	Power supply decoupling capacitor	1 μF, 1206

OUTLINE DIMENSIONS



ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
ADL5535ARKZ-R7	-40°C to +85°C	3-Lead SOT-89, 7" Tape and Reel	RK-3
ADL5535-EVALZ		Evaluation Board	

¹ Z = RoHS Compliant Part.

NOTES



www.analog.com

©2010–2013 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D08674-0-9/13(A)